



Part Number : [475531001](#)

Product Description : 1.27mm Pitch SIM Card Holder with 2 Detect Pins, 6 Circuits, Push-Push Style, Housing Height 1.80mm, with Pegs, Lead-Free

Series Number : 47553

Status : Active

Product Category : Memory / SIM Card Connectors



Documents and Resources

Drawings

[475531001_sd.pdf](#)

[PK-47553-001-001.pdf](#)

3D Models and Design Files

[STEP AP242](#)

[SOLIDWORKS](#)

[Creo](#)


[Symbol and Footprint \(Multi-Format\)](#)

Specifications

[PS-47553-001-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)7771-DC (04 Feb 2026)
EU RoHS	Compliant per EU 2015/863

[Compliance Statements](#)

- EU RoHS

- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	Memory / SIM Card Connectors
Series	47553
Description	1.27mm Pitch SIM Card Holder with 2 Detect Pins, 6 Circuits, Push-Push Style, Housing Height 1.80mm, with Pegs, Lead-Free
Comments	With Pegs
Product Name	mini-SIM
Style	Push-Push
UPC	800756882062

Electrical

Current - Maximum per Contact	0.5A
Shielded	Yes
Voltage - Maximum	50V DC

Physical

Card Detection Switch	Open
Card Entry Location	Front
Circuits (Loaded)	6
Circuits (maximum)	6

Durability (mating cycles max)	5000
Ejector Button Side	N/A
Material - Contact	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Gold
Material - Resin	High Temperature Thermoplastic
Material - Shell	Stainless Steel
Net Weight	2.692/g
Packaging Type	Embossed Tape on Reel
PCB Locator	Yes
PCB Retention	Yes
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	1.27mm
Temperature Range - Operating	-40° to +85°C
Termination Interface Style	Surface Mount

Solder Process Data

Max-Duration	10
Lead-Free Process Capability	REFLOW
Max-Cycle	2
Max-Temp	250

Mates With / Use With

Mates with Part(s)

Description	Part Number
Mates With	Standard SIM Card

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